MOSFETs Silicon N-channel MOS (U-MOSIX-H)

# TPN2R304PL

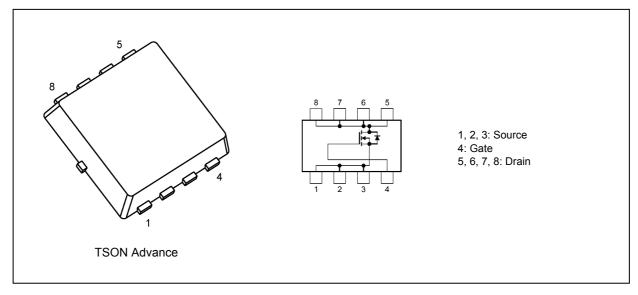
#### 1. Applications

- High-Efficiency DC-DC Converters
- Switching Voltage Regulators
- Motor Drivers

#### 2. Features

- (1) High-speed switching
- (2) Small gate charge:  $Q_{SW} = 10.8 \text{ nC}$  (typ.)
- (3) Small output charge:  $Q_{oss} = 27 \text{ nC}$  (typ.)
- (4) Low drain-source on-resistance:  $R_{DS(ON)} = 1.8 \text{ m}\Omega$  (typ.) ( $V_{GS} = 10 \text{ V}$ )
- (5) Low leakage current:  $I_{DSS} = 10 \ \mu A \ (max) \ (V_{DS} = 40 \ V)$
- (6) Enhancement mode:  $V_{th}$  = 1.4 to 2.4 V ( $V_{DS}$  = 10 V,  $I_D$  = 0.3 mA)

#### 3. Packaging and Internal Circuit



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#### 4. Absolute Maximum Ratings (Note) (T<sub>a</sub> = 25 °C unless otherwise specified)

Characteristi	cs		Symbol	Rating	Unit
Drain-source voltage			V <sub>DSS</sub>	40	V
Gate-source voltage			V <sub>GSS</sub>	±20	
Drain current (DC)	(T <sub>c</sub> = 25 °C)	(Note 1), (Note 2)	Ι <sub>D</sub>	80	Α
Drain current (DC)	(Silicon limit)	(Note 1), (Note 2)	Ι <sub>D</sub>	100	A
Drain current (pulsed)	(t = 100 μs)	(Note 1)	I <sub>DP</sub>	200	A
Power dissipation	(T <sub>c</sub> = 25 °C)		PD	104	W
Power dissipation		(Note 3)	PD	2.67	w
Power dissipation		(Note 4)	PD	0.63	W
Single-pulse avalanche energy		(Note 5)	E <sub>AS</sub>	39	mJ
Single-pulse avalanche current		(Note 5)	I <sub>AS</sub>	80	A
Channel temperature			T <sub>ch</sub>	175	°C
Storage temperature			T <sub>stg</sub>	-55 to 175	°C

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

#### 5. Thermal Characteristics

Characteristics			Symbol	Max	Unit
Channel-to-case thermal resistance	(T <sub>c</sub> = 25 °C)		R <sub>th(ch-c)</sub>	1.43	°C/W
Channel-to-ambient thermal resistance	(T <sub>a</sub> = 25 °C)	(Note 3)	R <sub>th(ch-a)</sub>	56	
Channel-to-ambient thermal resistance	(T <sub>a</sub> = 25 °C)	(Note 4)	R <sub>th(ch-a)</sub>	235	

Note 1: Ensure that the channel temperature does not exceed 175 °C.

Note 2: Limited by package limit. Silicon chip capability is 100 A. ( $T_c = 25 \text{ °C}$ )

Note 3: Device mounted on a glass-epoxy board (a), Figure 5.1

Note 4: Device mounted on a glass-epoxy board (b), Figure 5.2

Note 5:  $V_{DD}$  = 32 V,  $T_{ch}$  = 25 °C (initial), L = 4.7  $\mu$ H, I<sub>AS</sub> = 80 A

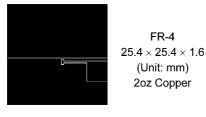
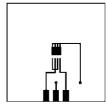


Fig. 5.1 Device Mounted on a Glass-Epoxy Board (a)



FR-4 25.4 × 25.4 × 1.6 (Unit: mm) 2oz Copper

Fig. 5.2 Device Mounted on a Glass-Epoxy Board (b)

Note: This transistor is sensitive to electrostatic discharge and should be handled with care.

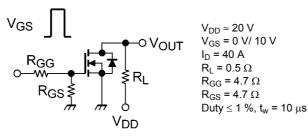
#### 6. Electrical Characteristics

#### 6.1. Static Characteristics (T<sub>a</sub> = 25 °C unless otherwise specified)

Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Gate leakage current	I <sub>GSS</sub>	$V_{GS}$ = ±20 V, $V_{DS}$ = 0 V	_	_	±0.1	μA
Drain cut-off current	I <sub>DSS</sub>	V <sub>DS</sub> = 40 V, V <sub>GS</sub> = 0 V	_	_	10	
Drain-source breakdown voltage	V <sub>(BR)DSS</sub>	I <sub>D</sub> = 10 mA, V <sub>GS</sub> = 0 V	40	_	—	V
	V <sub>(BR)DSX</sub>	$I_{D}$ = 10 mA, $V_{GS}$ = -20 V	25	_	—	
Gate threshold voltage	V <sub>th</sub>	V <sub>DS</sub> = 10 V, I <sub>D</sub> = 0.3 mA	1.4	_	2.4	
Drain-source on-resistance	R <sub>DS(ON)</sub>	V <sub>GS</sub> = 4.5 V, I <sub>D</sub> = 15 A	_	2.8	4.0	mΩ
		V <sub>GS</sub> = 10 V, I <sub>D</sub> = 40 A		1.8	2.3	

#### 6.2. Dynamic Characteristics ( $T_a = 25$ °C unless otherwise specified)

Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Input capacitance	C <sub>iss</sub>	V <sub>DS</sub> = 20 V, V <sub>GS</sub> = 0 V, f = 1 MHz		2750	3600	pF
Reverse transfer capacitance	C <sub>rss</sub>	]		66	122	
Output capacitance	C <sub>oss</sub>			650	—	
Gate resistance	r <sub>g</sub>	—		0.5	1.0	Ω
Switching time (rise time)	t <sub>r</sub>	See Fig. 6.2.1		7.8	_	ns
Switching time (turn-on time)	t <sub>on</sub>	]		17.5	_	
Switching time (fall time)	t <sub>f</sub>	]		12.2	_	
Switching time (turn-off time)	t <sub>off</sub>	]		37	_	



#### Fig. 6.2.1 Switching Time Test Circuit

#### 6.3. Gate Charge Characteristics ( $T_a = 25$ °C unless otherwise specified)

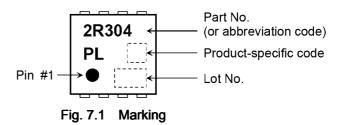
Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Total gate charge (gate-source plus	Qg	$V_{DD}\approx 20~V,~V_{GS}$ = 10 V, $I_{D}$ = 40 A	_	41	_	nC
gate-drain)		$V_{DD} \approx 20$ V, $V_{GS}$ = 4.5 V, $I_D$ = 40 A	_	19.4	_	
Gate-source charge 1	Q <sub>gs1</sub>	$V_{DD} \approx 20$ V, $V_{GS}$ = 10 V, $I_D$ = 40 A	_	9.6	_	
Gate-drain charge	Q <sub>gd</sub>		_	6.2	_	
Gate switch charge	Q <sub>SW</sub>		_	10.8	_	
Output charge	Q <sub>oss</sub>	V <sub>DS</sub> = 20 V, V <sub>GS</sub> = 0 V	_	27	_	

#### 6.4. Source-Drain Characteristics ( $T_a = 25 \ ^{\circ}C$ unless otherwise specified)

Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Reverse drain current (pulsed) (Note 6)	I <sub>DRP</sub> (t = 100 μs)	—	—	—	200	A
Diode forward voltage	V <sub>DSF</sub>	I <sub>DR</sub> = 80 A, V <sub>GS</sub> = 0 V		—	-1.2	V
Reverse recovery time	t <sub>rr</sub>	V <sub>R</sub> = 20 V, I <sub>DR</sub> = 20 A, V <sub>GS</sub> = 0	_	35	—	ns
Reverse recovery charge	Q <sub>rr</sub>	V, -dI <sub>DR</sub> /dt = 100 A/μs	_	30	_	nC

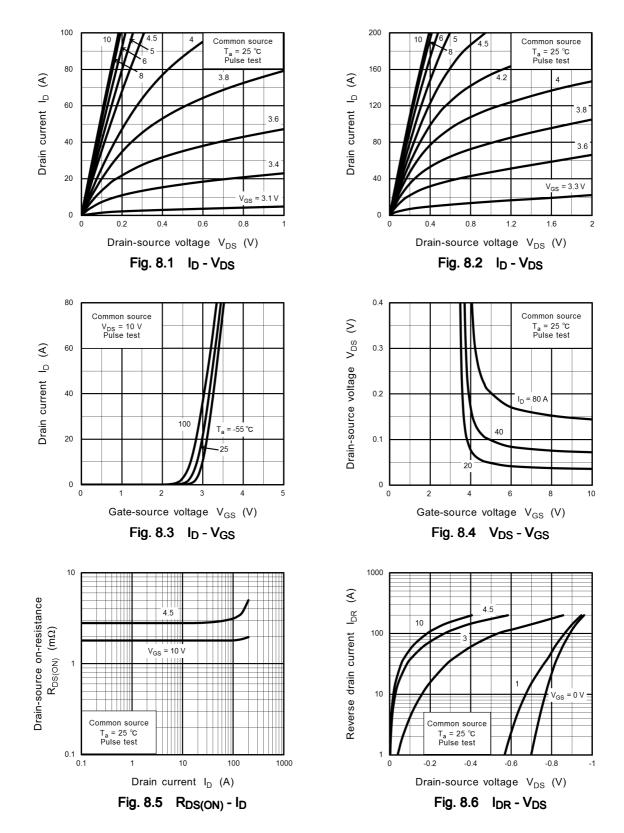
Note 6: Ensure that the channel temperature does not exceed 175 °C.

#### 7. Marking



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#### 8. Characteristics Curves (Note)



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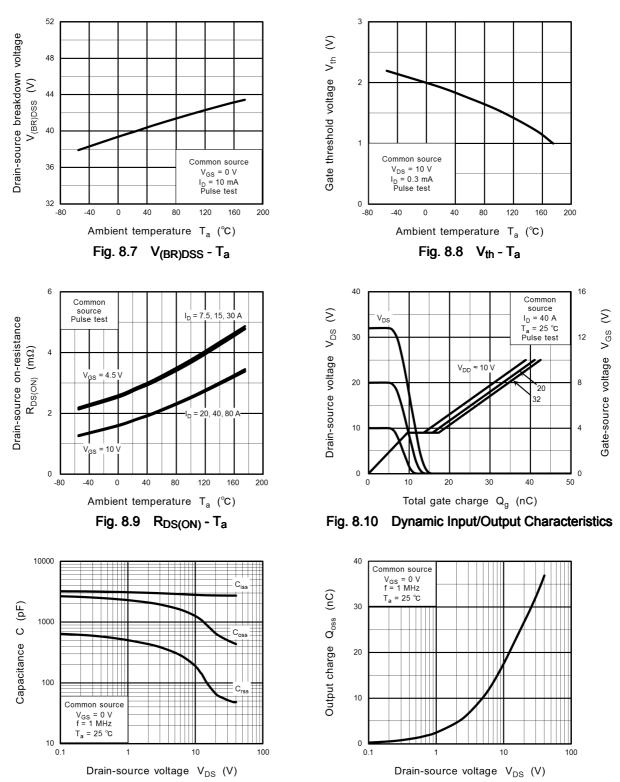
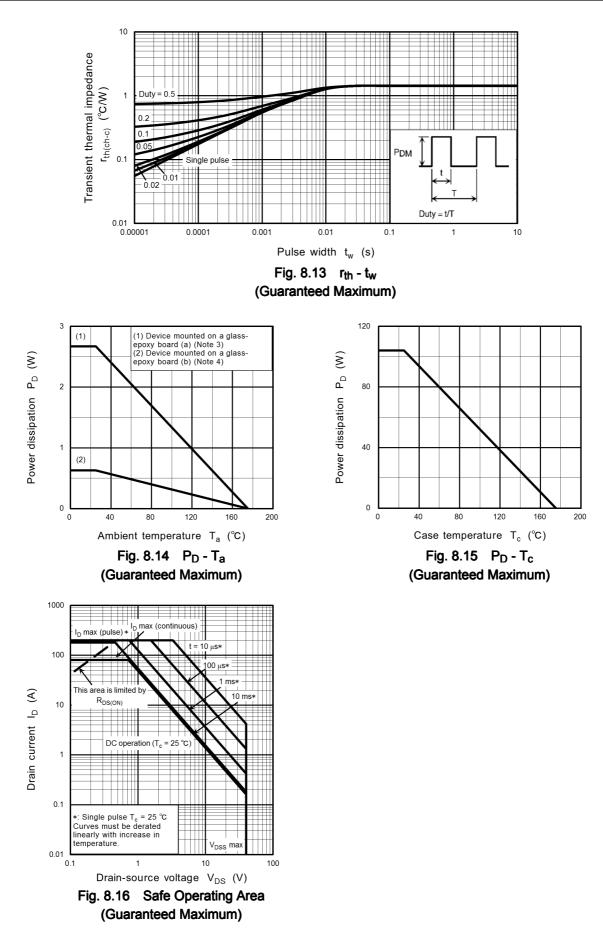


Fig. 8.11 Capacitance - V<sub>DS</sub>

Fig. 8.12 Qoss - VDS



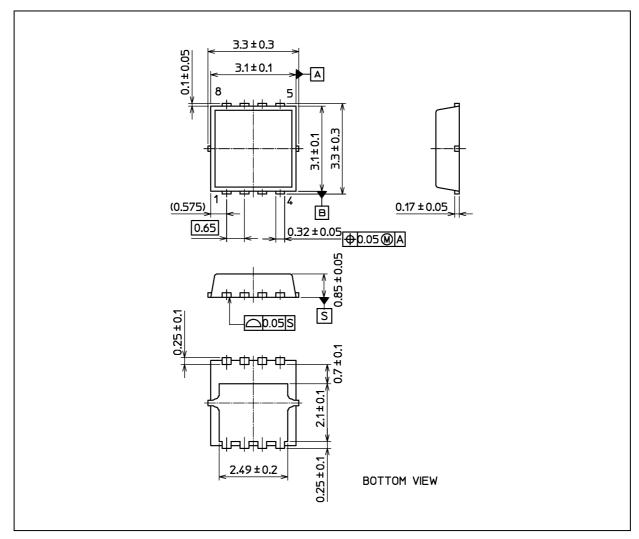
Note: The above characteristics curves are presented for reference only and not guaranteed by production test, unless otherwise noted.



### TPN2R304PL

#### **Package Dimensions**

Unit: mm



Weight: 0.02 g (typ.)

Package Name(s)
TOSHIBA: 2-3X1S
Nickname: TSON Advance

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